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(71) Applicant (for all designated States except US): **ELECTRO SCIENTIFIC INDUSTRIES, INC.** [US/US];
13900 NW Science Park Drive, Portland, OR 97229 (US).

(72) Inventors; and

(75) Inventors/Applicants (for US only): **SUN, Yunlong** [US/US]; 7679 SW 194th Terrace, Beaverton, OR 97007 (US). **JINJIAO, Liu** [CN/CN]; 1-306 Ta-Yuan Xiaoxia Yuan, HaiDian District, Beijing 100083 (CN). **HARRIS, Richard, S.** [US/US]; 16155 NW Canterwood Way, Portland, OR 97229 (US). **SUBRAHMANYAN, Pradeep**

[US/US]; 16440 SW Blackbird Drive, Beaverton, OR 97007 (US). **HAINSEY, Robert, F.** [US/US]; 3517 NE Bryce Street, Portland, OR 97212 (US). **LU, Weixiong** [CN/US]; 9739 NW Bartholomew Drive, Portland, OR 97229 (US).

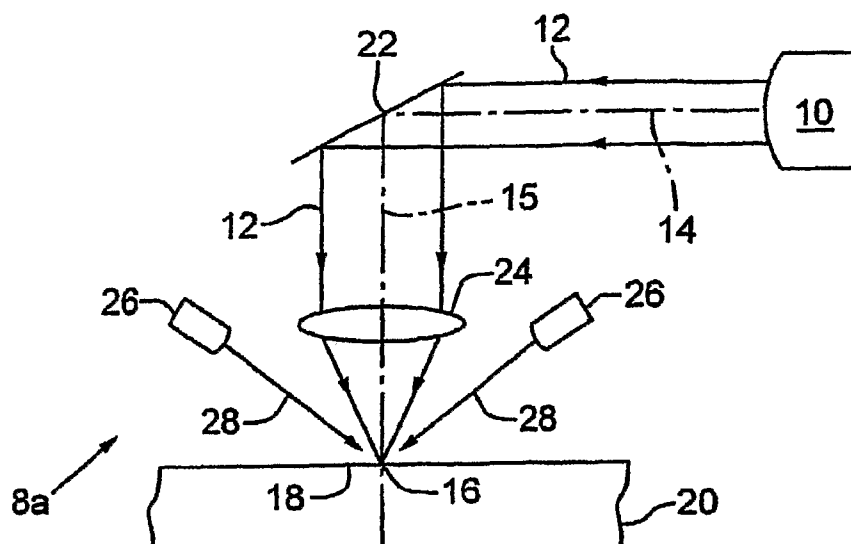
(74) Agent: **SZCZERBICKI, Sandra, K.**; Stoel Rives, LLP, 900 S.W. Fifth Avenue, Suite 2600, Portland, OR 97204-1268 (US).

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(54) Title: LASER PROCESSING OF A LOCALLY HEATED TARGET MATERIAL



(57) Abstract: A method and laser system effect rapid removal of material from a workpiece (20) by applying heating energy in the form of a light beam (28) to a target location (16) on the workpiece to elevate its temperature while maintaining its dimensional stability. When the target portion of the workpiece is heated, a laser beam (12) is directed for incidence on the heated target location. The laser beam preferably has a processing laser output that is appropriate to effect removal of the target material from the workpiece. The combined incidence of the processing laser output and the heating energy on the target location enables the processing laser output to remove a portion of the target material at a material removal rate that is higher than the material removal rate achievable when the target material is not heated.

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